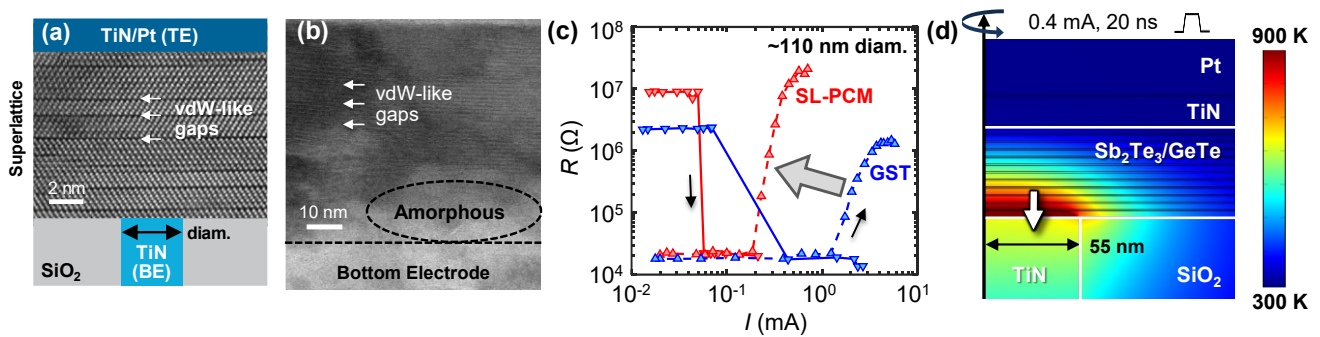


# Novel Chalcogenide Superlattice-Based Energy-Efficient Phase-Change Memory for 3D Heterogeneous Integration

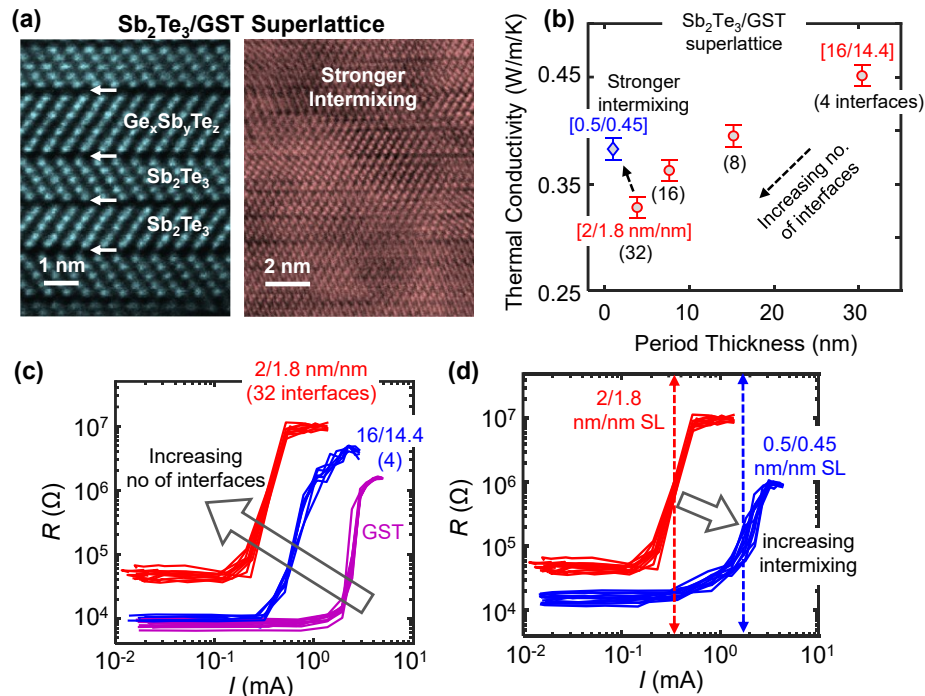
Asir Intisar Khan<sup>1</sup>, Xiangjin Wu<sup>1</sup>, Alwin Daus<sup>1</sup>, Heungdong Kwon<sup>2</sup>, Kenneth E. Goodson<sup>2</sup>, H.-S. Philip Wong<sup>1</sup>, and Eric Pop<sup>1</sup>

<sup>1</sup>Department of Electrical Engineering, Stanford University, Stanford, CA, 94305, USA

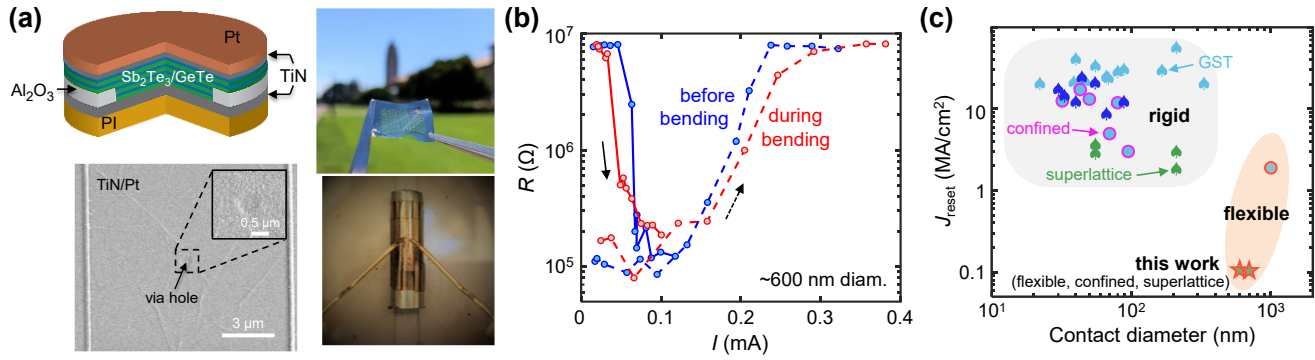
<sup>2</sup>Department of Mechanical Engineering, Stanford University, Stanford, CA, 94305, USA



**Fig. 1: Superlattice Phase-Change Memory (PCM) [1].** (a) Schematic of superlattice (SL) PCM device with alternating thin chalcogenide layers having van der Waals-like interfaces. (b) High-resolution scanning transmission microscope (STEM) cross-section of an SL-PCM device in the high resistance state. (c) Resistance ( $R$ ) vs. current ( $I$ ) in SL-PCM vs. control GST PCM showing  $\sim 10\times$  reduction in switching current for SL-PCM. (d) Electro-thermal simulation showing strong heat confinement in SL-PCM.



**Fig. 2: Superlattice (SL) Materials-Device Correlation [2].** (a) STEM images of SLs comparing good quality vs. intermixed SL. (b) Interface controlled cross-plane thermal conductivity in Sb<sub>2</sub>Te<sub>3</sub>/GST superlattice. Measured  $R$  vs.  $I$  in SL-PCM showing (c) reduction of switching current with increasing SL interfaces, and (d) increase in the switching current due to intermixing within the SL interfaces. Here, the bottom electrode diameter  $\sim 110$  nm.



**Fig. 3: Flexible Superlattice Phase-Change Memory** [3]. **(a)** Schematic, scanning electron microscope and photographs of our superlattice PCM on flexible polyimide (PI) substrate. **(b)** Resistance ( $R$ ) vs. current ( $I$ ) in flexible SL-PCM with 600 nm bottom electrode diameter showing low switching current both before and during bending. **(c)** Record-low switching current-density in flexible superlattice PCM compared to existing demonstrations of PCM technology.

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